

P-Channel 60V MOSFETs

Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- -60V,-20A, RDS(ON) = $48m\Omega$ @VGS = -10V
- Improved dv/dt capability
- Green Device Available
- 100% EAS Guaranteed
- Fast Switching
- RoHS compliant package

Application

- Motor Drive
- Power Tools
- LED Lighting

Package type: TO-252

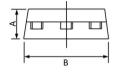
Packing & Order Information

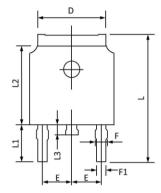
R: 2,500/Reel

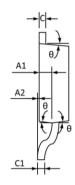
T: 80/Tube; 4,000/Box





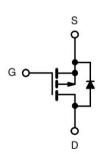






Crombal	Dimensions In	Millimeters	Dimension	s In Inches	
Symbol	Min	Max	Min	Max	
A	2.20	2.40	0.087	0.094	
A1	0.91	1.11	0.036	0.044	
A2	0.00	0.15	0.000	0.006	
В	6.50	6.70	0.256	0.264	
C	0.46	0.580	0.018	0.230	
C1	0.46	0.580	0.018	0.030	
D	5.10	5.46	0.201	0.215	
E	2.186	2.386	0.086	0.094	
F	0.74	0.94	0.029	0.037	
F1	0.660	0.860	0.026	0.034	
L	9.80	10.40	0.386	0.409	
L1	2.9R	EF	0.114REF		
L2	6.00	6.20	0.236	0.244	
L3	0.60	1.00	0.024	0.039	
θ	3°	9°	3°	9°	

Graphic symbol



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)					
Symbol	Parameter	Value	Unit		
V_{DS}	Drain to Source Voltage	-60	V		
V_{GS}	Gate to Source Voltage	±20	V		
I_{D}	Continuous Drain Current (TC=25°C)	-20	A		
1D	Continuous Drain Current (TC=100°C)	-13	A		
I_{DM}	Drain Current Pulsed	-80	A		
Eas	Single Pulsed Avalanche Energy ²	51	mJ		
Ias	Single Pulsed Avalanche Current ²	-32	A		



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Absolute Maximum Ratings (Tc=25°C unless otherwise specified)					
Symbol	Parameter	Value	Unit		
PD	Power Dissipation (TC = 25°C) Power Dissipation – Derate above 25°C	46	W		
		0.37	W/°C		

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)						
Symbol	ol Parameter Value Unit					
T_{STG}	Storage Temperature Range	-55 to +150	°C			
TJ	Operating Junction Temperature Range	-55 to +150	°C			

Thermal Characteristics						
Symbol	Parameter		I T : 4			
Symbol	ratameter	Min.	Typ.	Max.	Units	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case			62	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient			1.22	°C/W	

Electrical Characteristics (TJ=25°C, unless otherwise noted)

Off Charac	cteristics					
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0 V , I_D = 250 μA	-60			V
ΔBV_{DSS} $/\Delta T_J$	BV _{DSS} Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		-0.05		V/°C
I _{DS S}	Drain-Source Leakage Current	$V_{DS} = -60 \text{ V}, T_J = 25^{\circ}\text{C}$ $V_{DS} = -48 \text{ V}, T_J = 125^{\circ}\text{C}$			-1 -10	uA
IGSS	Gate-Source Leakage, Forward	$V_{GS} = \pm 20 \text{ V}$, $V_{DS} = 0 \text{ V}$			±100	nA

On Charac	cteristics					
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS},I_D=250~uA$	-1.2	-1.6	-2.5	V
D	Static Drain-Source	$V_{GS} = -10 \text{ V}, I_{D} = -8 \text{ A}$		39	48	mΩ
R _{DS(ON)}	On-state Resis-tance	$V_{GS} = -4.5 \text{ V}$, $I_D = -4 \text{ A}$		53	65	
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$		5		mV/°C
gfs	Forward Transconductance	$V_{GS} = -10V$, $I_D = -6$ A		11		S



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Dynamic (Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
Qg	Total Gate Charge ^{3,4}	$V_{DS} = -30 \text{ V},$		22.4	31	nC	
Q_{gs}	Gate-Source Charge ^{3,4}	$V_{GS} = -10 \text{ V},$		4.1	6	nC	
Q_{gd}	Gate-Drain Charge ^{3,4}	$I_D = -8 A$		5.2	8	nC	
t _{d(on)}	Turn-On Delay Time 3,4	$V_{DD} = -30 \text{ V},$		13	25	ns	
$t_{\rm r}$	Rise Time ^{3,4}	$I_D = -1 A,$		42.4	81	ns	
$t_{d(off)}$	Turn-Off Delay Time 3,4	$V_{GS} = -10 \text{ V},$		64.6	123	ns	
tf	Fall Time ^{3,4}	$R_G = 6 \Omega$		16.4	31	ns	

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
C_{ISS}	Input Capacitance	$V_{GS} = 0 V$,		1250	1810	pF
Coss	Output Capacitance	$V_{DS} = 25 \text{ V},$		85	125	pF
C _{RSS}	Reverse Transfer Capacitance	f = 1 MHz		65	95	pF
Rg	Gate resistance	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ V}, F=1 \text{MHz}$		15	30	Ω

Drain-Sou	Drain-Source Diode Characteristics and Maximum Ratings						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
I_S	Continuous Source Current	$V_D=V_G=0V$			-20	A	
I_{SM}	Pulsed Source Current	Force Current			-80	A	
V_{SD}	Diode Forward Voltage	$I_S = -1 A$, $V_{GS} = 0 V$, $TJ = 25$ °C			-1	V	
t_{rr}	Reverse Recovery Time ³	$V_{GS} = 0$, Is = -1 A,				ns	
Qrr	Reverse Recovery Charge ³	dI/dt=100A/us, TJ=25°C				uC	

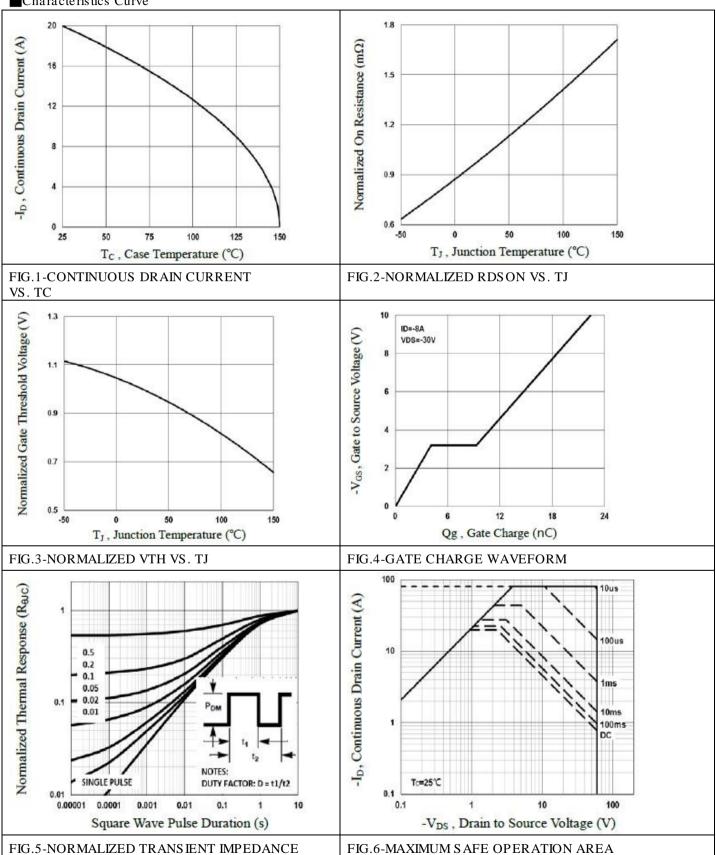
Note:

- 1.Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2.VDD=-25V,VGS=-10V,L=0.1 mH,IAS=-32A.,RG=25 Ω ,Starting TJ=25 $^{\circ}$ C
- 3. The data tested by pulsed , pulse width $\leq 300 \, \text{us}$, duty cycle $\leq 2\%$.
- 4. Essentially independent of operating temperature.



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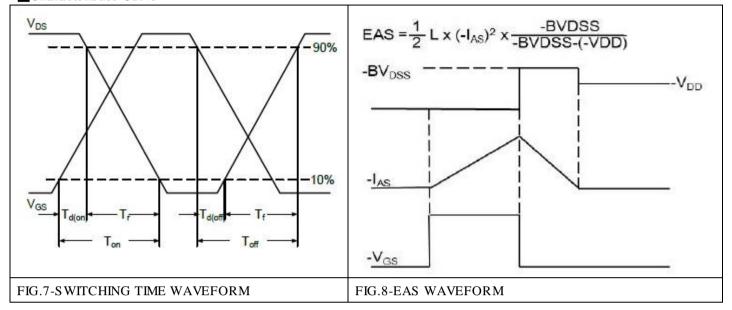
Characteristics Curve





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Characteristics Curve





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